

BL i.MX8M Mini

Doc. Rev 3.1

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Revision History

Table 1: Revision History

| Revision | Brief Description of Changes | Date of Issue | Author/Editor |
|----------|--|---------------|---------------|
| Rev. 0.1 | Initial draft version | 2020-12-08 | Arn/KI |
| Rev. 1.0 | Final release | 2020-12-21 | Arn |
| Rev. 1.1 | Formatting and text corrections | 2021-09-24 | We |
| Rev. 2.0 | Many corrections and additions | 2022-03-01 | We |
| Rev. 3.0 | Many improvements and changes, new design version, revision for internal purposes only | 2025-04-06 | We |
| Rev. 3.1 | Release of the new design | 2025-05-19 | We |

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If you have any difficulties using this user guide, discover an error, or just want to provide some feedback, contact support@kontron-electronics.de. Detail any errors you find. We will correct the errors or problems as soon as possible and provide the revised user guide.

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3 Symbols

The following Symbols may be used in this user guide:



DANGER

Indicates an imminently hazardous situation, which, if not avoided, will result in death or serious injury.



WARNING

Indicates a potentially hazardous situation which, if not avoided, could result in death or serious injury.



CAUTION

Indicates a potentially hazardous situation which, if not avoided, may result in minor or moderate injury. It may also be used to alert against unsafe practices.



NOTICE

Indicates a property damage message.



ESD Sensitive Device

This symbol and title inform that the electronic boards and their components are sensitive to static electricity. Care must always therefore be taken during all handling operations and inspections of this product in order to ensure product integrity at all times.



HOT Surface

Do NOT touch! Allow to cool before servicing.



Information

This symbol indicates general information about the product and the user guide.



Hints and Tips

This symbol precedes helpful hints and tips for daily use.

4 Safety Instructions

Before you begin the installation and operation of the product, please carefully read all safety instructions and warnings. Pay attention to any warning notices attached. Kontron Electronics accepts no liability for damage to equipment or persons resulting from failure to follow the basic safety instructions, even during the warranty period, and is therefore exempt from statutory liability for accidents. The product has been designed and tested in accordance with basic safety requirements and legal guidelines. To ensure safe operation, the user must not only observe the intended operating conditions of the product but also follow the basic safety instructions:

- The product must be used in accordance with the user guide or datasheet.
- All instructions for installation, operation, maintenance, transport or storage that are necessary for the safety of the product or the user must be followed.
- The electrical connection on site must comply with the requirements of the local, country-specific regulations.
- Do not place the appliance near heat sources or in damp locations.
- The only way to completely disconnect the product from the mains power is to disconnect the power supply cable from the power adapter or from the product itself.
- Note: The product is not disconnected from the power supply when it is switched off using the power button or the software.
- Only original accessories approved by Kontron Electronics may be used.
- The available interfaces may only be used with devices and components that comply with the specifications listed in the user guide.
- Ensure that the power consumption of the product does not exceed the value specified on the rating plate and in the user-guide.
- If the product stops working properly, switch it off and secure it to prevent it from being turned on again.
- Basic ESD protection measures must be observed (see user guide).
- AL and DL series products should only be opened to replace a depleted battery. Before opening the housing, disconnect the power supply and ensure that the product is completely de-energized. Ensure that all interfaces of the device are also disconnected.



WARNING

Risk of explosion if the battery is not replaced according to the instructions! (short circuit, reverse polarity, incorrect battery type). Dispose of used batteries in accordance with the manufacturer's instructions.



CAUTION: Risk of Overheating

Sufficient air circulation or cooling is essential to protect the product from overheating. When cooling by air circulation, make sure that the ventilation openings and heat sinks of the product are not covered. Overheating can affect the proper functioning of the product and, in the worst case, lead to its destruction. High ambient temperatures can make cooling more difficult. The ambient temperature limits specified in the user guide must be observed.



CAUTION: Hot Surface

There is a risk of injury from contact with heated components or the housing.

Important notes on the power supply

- Please note: Safe use of the product is only possible if the external DC power supply meets the criteria for LPS and PS2 (UL/IEC 62368-1).
- Connect the product only to a power supply (PSU) that provides the input power (max. current) specified on the Kontron nameplate or in the User-Guide and that complies with the Limited Power Source (LPS) and Power Source (PS2) requirements of UL/IEC 62368-1.
- Safe operation is not possible if exposed parts of circuits carrying dangerous voltages or energies can be touched directly or indirectly.
- Safe operation is not possible if there is no disconnecting device that removes the hazardous energy content from the point of disconnection within 2 seconds.
- The cross-section of the supply wires must be selected in accordance with the maximum current specified on the nameplate of the device, in accordance with the provisions of EN62368-1 or VDE0100 or EN60204 or UL61010-1.
- The power supply serves as the primary disconnect device from the mains (AC) and is used to remove all DC power from the board / system.
- The AL or DL housing must be earthed using the screw provided.

Additional safety information for BL

Please note when extending the device:

- When installing additional modules, ensure that the workspace is clean.
- After installing the additional modules, please check the product for any damage.
- The power consumption of each additional module must not exceed the specified limit.
- Structural changes and modifications must be approved by Kontron Electronics. Unauthorised structural modifications and conversions will result in the loss of any warranty.
- Only trained personnel are authorised to handle and operate the device.

Additional safety instructions for the Development Kit

- Regularly check the unit's components, accessories and power supply for damage.
- Only trained personnel are authorised to handle and operate the appliance.
- The product is a customised, application-specific test module intended for exclusive use by experts in research and development facilities for research and development purposes. (§2 section 3 paragraph 3 EMVG)

5 Instructions on Handling, Unpacking and Usage

5.1 ESD („Electrostatic Discharge“)



ESD Sensitive Device

Electrostatic discharge (ESD) can damage equipment and impair electrical circuitry.

- Wear ESD-protective clothing and shoes.
- Wear an ESD-preventive wrist strap attached to a good earth ground.
- Check the resistance value of the wrist strap periodically (OK: 1 MΩ to 10 MΩ).
- Transport and store the board in its antistatic bag.
- Handle the board at an approved ESD workstation.
- Handle the board only by the edges.

Do not handle this product out of its protective enclosure while it is not used for operational purposes unless it is otherwise protected.

Whenever possible, unpack or pack this product only at EOS/ESD safe workstations. Where a safe workstation is not guaranteed, it is important for the user to be electrically discharged before touching the product with hands or tools.

It is particularly important to observe standard anti-static precautions when changing piggybacks, ROM devices, jumper settings etc. If the product contains batteries for RTC or memory backup, ensure that the product is not placed on conductive surfaces, including anti-static plastics or sponges. They can cause short circuits and damage the batteries or conductive circuits on the product.

5.2 Packaging

All parts are delivered together in a product specific cardboard package designed to provide adequate protection and absorb shock. Kontron Electronics recommends keeping the packaging to store or transport the product. If it is necessary to store or ship the product then repack it in the same manner as it was delivered.

Please inspect the delivery immediately upon receipt for completeness and integrity. Check the product, the packaging, and any seals that may be present for visible damage or signs of tampering.

If you notice any discrepancies, damage, or missing components, please contact our support team without delay.



Unpacking

Proceed as follows to unpack the unit:

- Remove packaging.
- Do not discard the original packaging. Keep packaging for future relocation or storage.
- Check the delivery for completeness by comparing it with the original order.
- Keep the associated paperwork. It contains important information for handling the unit.
- Check the contents for visible shipping damage.

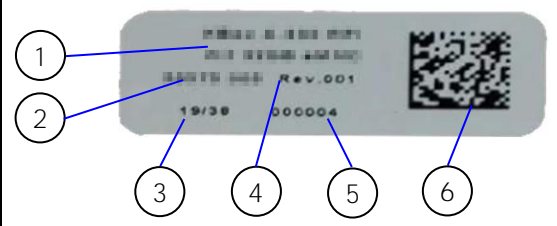

5.3 Scope of Delivery

Included in this delivery:

- BL i.MX8M Mini
- Safety Instructions
- DC Power Connector (2-pin Phoenix Contact)

5.4 Label and Product Identification

Figure 1: BL i.MX8M Mini Label (Example)

| | | Detail | Description |
|--|---|--------|---|
|  | 1 | | Product name (BL i.MX8M Mini) |
| | 2 | | Article number |
| | 3 | | Production date |
| | 4 | | Revision number |
| | 5 | | Serial number |
|  | 6 | | Barcode with article-, rev., date and serial number |
| | 7 | | MAC address |
| | 8 | | MAC address (barcode) |

5.5 General Instructions on Usage

In order to maintain Kontron Electronics' product warranty, this product must not be altered or modified in any way. Changes or modifications to the product, that are not explicitly approved by Kontron Electronics and described in this user guide or received from Kontron Electronics Support as a special handling instruction, will void your warranty.

This product should only be installed in or connected to systems that fulfil all necessary technical and specific environmental requirements. This also applies to the operational temperature range of the specific board version that must not be exceeded. If batteries are present, their temperature restrictions must be considered.

In performing all necessary installation and application operations, only follow the instructions supplied by the present user guide.

6 Introduction

This user guide describes the single board computer BL i.MX8M Mini. The Advanced RISC Machines (ARM) based module is equipped with NXP i.MX8M Mini processor. The quad core SoC takes advantage of the optimized power consumption and performance ratio.

The use of this user guide implies a basic knowledge of PC hardware and software. This user guide is focused on describing the special features and is not intended to be a standard PC textbook. New users are recommended to study the short installation procedure, before switching on the power.

All configuration and setup of the module is performed using the u-Boot CLI. Latest revision of this user guide, datasheet, and BSPs (Board Support Packages) can be downloaded from Kontron Electronics Web Page.

Kontron Electronics' BL i.MX8M Mini is developed specifically for sophisticated 3D graphics applications and computing-intensive system architectures. The fanless design ensures a significantly prolonged lifespan and high system availability.



Exploring the BL i.MX8M Mini

Before working with the BL i.MX8M Mini, Kontron Electronics recommends that users take a few minutes to learn about the various parts of the BL i.MX8M Mini.

7 Starting Up

Before using the system, become familiar with the system components and follow the startup instructions below.

7.1 Connecting to Power Supply

The BL i.MX8M Mini connects to a DC main power supply via a Phoenix Contact input power connector and corresponding power cable.



Information

When starting the BL i.MX8M Mini, Kontron Electronics recommends that the power cable should be the last connection made to the system. Following the proper cabling sequence helps prevent false power-on conditions, which could otherwise lead to operational failures.



CAUTION

Please make sure to read the safety instructions at the beginning of this user guide before connecting the BL i.MX8M Mini to a power supply.



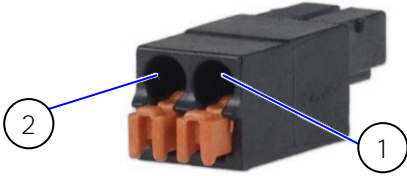
WARNING

The current of the power supply should be limited to 3 A.

7.2 Wiring the DC Mating Power Connector

The BL i.MX8M Mini is connected by the input power connector on the front to a DC power source via a DC power supply wiring consisting of the power mating connector and the assembled wires. For information on how to wire the connector, see next Chapter.

Table 2: Wiring the Power Mating Connector

| 2-Pin Power Mating Connector | Pin | Signal Name |
|---|-----|--------------------------------------|
|  | 1 | Location for inserting the 24 V wire |
| | 2 | Location for inserting the 0 V wire |
| | | |



WARNING

The current of the power supply should be limited to 3 A.

To wire the power mating connector, follow the steps below:

- Cut two (0.5...1.5 mm²) AWG 20...16 isolated wires to the required length and strip each end 5...7 mm.
- Twist the striped wire-ends and provide them with ferrules.
- Press the contact levers of the power mating connector down - far enough so that you can insert the end of the prepared wires.
- Insert the wires into the corresponding clamp of the Phoenix power mating connector. Make sure that you have the right polarity of the connection. For the pin assignment of the input power connector, refer to Chapter 10.2



Information

The wires used for power connections must be clearly marked (+/-) to ensure proper connection to the input power connector and to the main power source. In addition, the cables must have some form of support to minimize the strain on the unit's connectors.

7.3 Operating System (OS) and Drivers

The standard BL i.MX8M Mini is fully operational when switched on for the first time with pre-installed OS and drivers. Drivers are available from Kontron Electronics' GitLab Server <https://git.kontron-electronics.de>.

If ordered without pre-installed OS, before starting the BL i.MX8M Mini the operating system and the appropriate drivers need to be installed for the ordered system configuration.

8 Product Overview

The BL i.MX8M Mini is a flexible single board computer fanless device designed for use in demanding applications. Based on the i.MX8 (4x Arm® Cortex®-A53, 1x Arm® Cortex®-M4) Quad processor the BL i.MX8M Mini features long-term availability and supports a varied number of onboard interfaces to enable connectivity to nearly all applications. A microSD card slot supports memory expansion for flexible data storage.



Information

All variants are also available as a separate product named Automation-Line AL i.MX8M Mini in a robust steel chassis, designed for operation in a DIN rail environment.

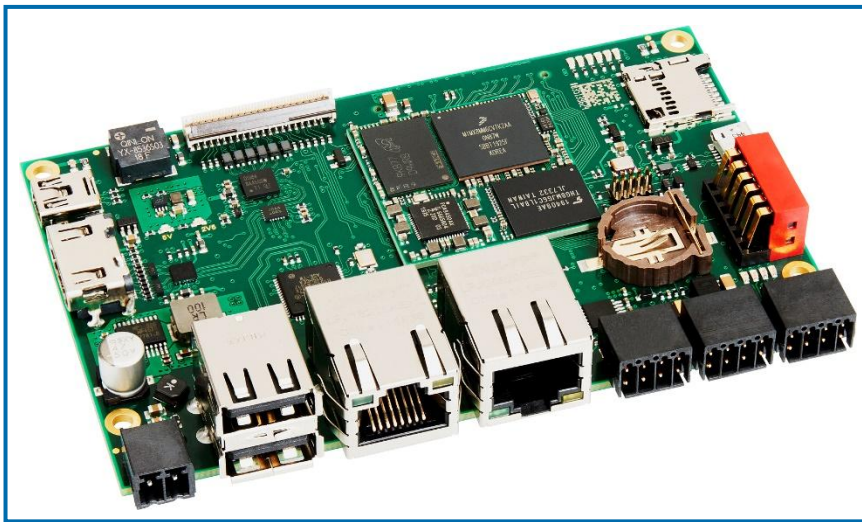


Figure 2: BL i.MX8M Mini

8.1 Main Characteristics

Main characteristics of the BL i.MX8M Mini are:

- i.MX8 MIMX8MM6CVTKZAA:
 - 4x Arm® Cortex®-A53 @1,6 GHz (1,8GHz)
 - 1x Arm® Cortex®-M4 processor @400 MHz
 - 2D GPU and 3D GPU
- 1 GB up to 4GB LPDDR4 RAM
- 8 GB up to 64 GB eMMC
- External microSD card slot
- External Interfaces: 1x HDMI, 2x Ethernet (1x Gbit/s, 1x 10/100 Mbit/s), 2x USB 2.0, 1x USB OTG, 1xRS232, 1x RS485, 1x CAN, 4x DIO (24 V / 800 mA), 1x LVDS, 1x Extension Connector
- Fanless passive cooling (heatsink required)

The BL i.MX8M Mini is intended for 24/7 continuous operation and longtime industrial applications. All components are selected to ensure a long lifetime.

8.2 Product Variants

Table 3: Product Variants of BL i.MX8M Mini

| Board | Description | Product Number |
|----------------------------|---|----------------|
| BL i.MX8M Mini 1 GB/8 GB | Board Line with NXP i.MX8M Mini quad core processor, 1 GB LPDDR4 and 8 GB eMMC | 40099 187 |
| BL i.MX8M Mini 4 GB/32 GB | Board Line with NXP i.MX8M Mini quad core processor, 4 GB LPDDR4 and 32 GB eMMC | 40099 220 |
| DK i.MX8M Mini 4GB/32 GB | Board Line, Power Supply, Connector Set, Debug-Adapter, USB-Cable | 50099 065 |
| DK 7" i.MX8M Mini 4GB/32GB | Board Line, Power Supply, Connector Set, Debug-Adapter, USB-Cable, 7" Touch Display | 50099 094 |
| Other systems on request | | |

8.3 Related Products and Accessories

The following products are available with the i.MX8M Mini:

- SL i.MX8M Mini (SoM Line)
- BL i.MX8M Mini (Board Line, including soldered-on SL i.MX8M Mini)
- DK i.MX8M Mini (Development Kit, including BL i.MX8M Mini)
- AL i.MX8M Mini (Automation Line, including BL i.MX8M Mini)
- DL i.MX8M Mini (Display Line, including BL i.MX8M Mini)
- Other systems on request

Table 4: Accessories of BL i.MX8M Mini

| Item | Description | Product Number |
|--|--|----------------|
| MicroSD Card | MicroSD Card 16 GB | 1 0600 338 |
| Power Supply | External power supply 230 V AC to 24 V DC / 18 W incl. 2-pin power connector (Phoenix Contact origin no. 1826680) | 30099 001 |
| Connector Set RS232/RS485/CAN/DIO mating connector | Connector set contains: ➤ 1x RS232: 8-pin; ➤ 1x RS485/CAN: 8-pin; ➤ 1x DIO: 8-pin (Phoenix Contact origin no. 1844594) | 30099 006 |
| USB-UART Debug-Adapter | Translates the UART signals provided on the Mini-B USB connector to USB for connecting the BL i.MX8M Mini to a computer | 40099 101 |
| USB-Cable | Connects the Mini-B Debug connector of the BL i.MX8M Mini to the USB-A of the Debug-Adapter | 1 860 1154 |

9 System Specification

9.1 Technical Specification

The BL i.MX8M Mini implements the following technical specification.

Table 5: Technical Specification

| | |
|-------------------|---|
| Processor | <ul style="list-style-type: none"> ➤ 4x Arm® Cortex®-A53 @1.6 GHz, ➤ 1x Arm® Cortex®-M4 @400 MHz, 2D GPU and 3D GPU |
| System Memory | <ul style="list-style-type: none"> ➤ LPDDR4-RAM 1 GB up to 4 GB |
| Storage | <ul style="list-style-type: none"> ➤ 8 GB eMMC up to 64 GB ➤ 2 MB NOR Flash ➤ 64 kbit EERAM (nvSRAM) |
| Interfaces | <ul style="list-style-type: none"> ➤ 2x USB 2.0, USB A ➤ 1x USB OTG, Micro-USB ➤ 1x Debug, Mini-B USB ➤ 1x 1 Gbit/s, 1x 10/100 Mbit/s Ethernet, RJ45 ➤ 1x HDMI ➤ 1x RS232, 1x RS485 ➤ 1x CAN ➤ 4x DIO (24 V DC / up to 800 mA) ➤ 1x LVDS |
| Expansion Sockets | <ul style="list-style-type: none"> ➤ 1x MicroSD Card Slot ➤ 1x Extension Connector |
| Power | <ul style="list-style-type: none"> ➤ 24 V DC ±20 % Input |

Table 6: Software Specification

| | |
|-----------------------|--|
| Operating System (OS) | <p>Yocto Linux</p> <p>BSP (demo) documentation and support: https://docs.kontron-electronics.de</p> |
|-----------------------|--|

9.2 Environmental Specification

Table 7: Environmental Conditions

| | |
|-------------------------|-------------------------------------|
| Temperature (Operating) | 0°C...70 °C ambient, non-condensing |
| Temperature (Storage) | -20...70 °C ambient, non-condensing |
| Pollution | Degree II |



Cooling

The BL i.MX8M Mini is designed for operation in a customer-specific enclosure or device. Please do not operate the BL i.MX8M Mini without sufficient cooling system. The maximum temperature range refers only to the limits of the individual components. Do not place heat sources in close proximity to the product. This could otherwise lead to performance losses or an unexpected shutdown of the device.

9.3 Mechanical Specification

Table 8: Mechanical Specification

| Dimension | BL i.MX8M Mini (Form Factor 4,3") |
|-----------|-------------------------------------|
| Width | 105,5 mm (4,15") |
| Depth | 67 mm (2,64") |
| Height | 24 mm (0,94") Screw mounting (M2.5) |
| Weight | Approx. ~0,07 kg (~0,15 lbs.) |
| Mounting | Screw mounting (M2.5) |

For more detailed mechanical information, refer to the following outline dimensions drawing features such as the position and size of mounting holes.

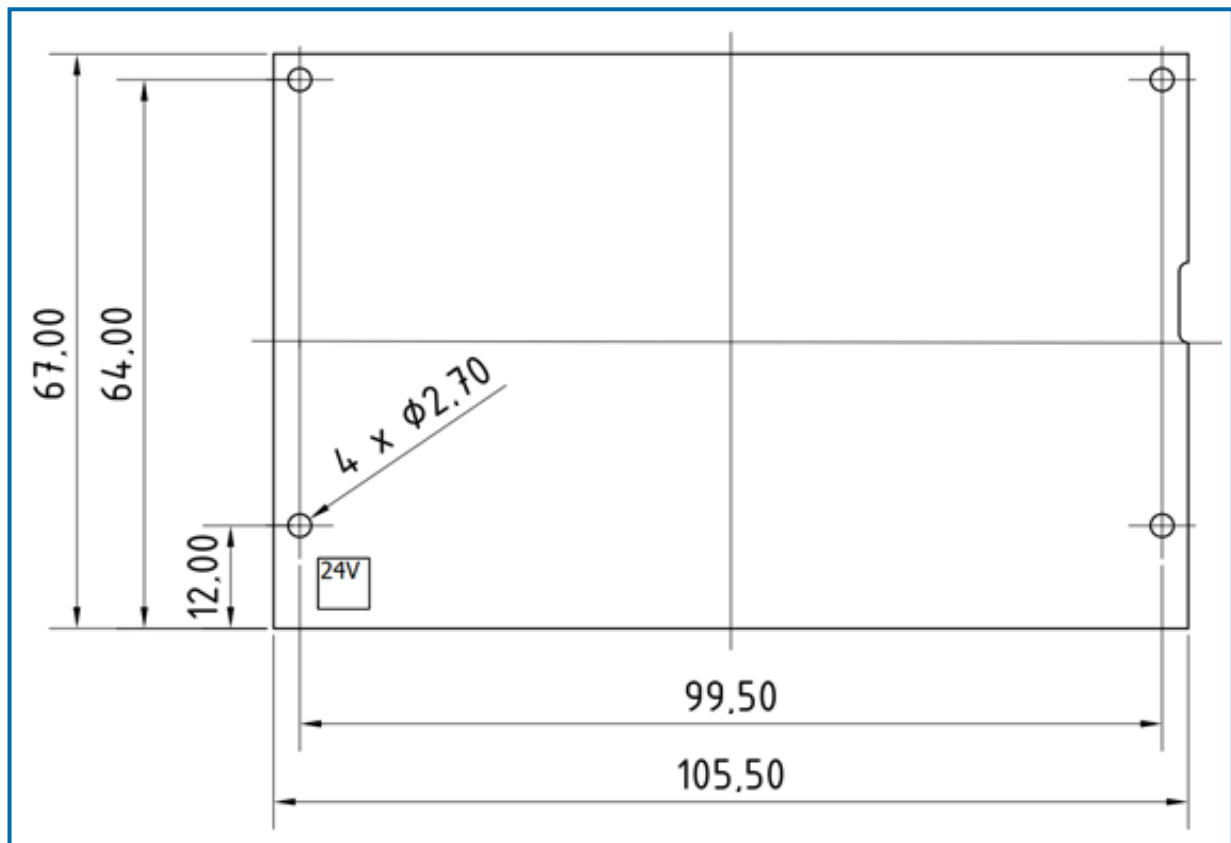


Figure 3: Board Dimensions

(Measurements in Millimetres)

9.4 Power Specification

The BL i.MX8M Mini is powered by a 2-pin input power connector on the front and has no internal power supply. The standard input voltage of 24 V DC is converted internally to supply all other required voltages.



WARNING

The current of the power supply should be limited to 3 A.



NOTICE

Performing a forced shutdown can lead to loss of data!

Table 9: Power Specification

| | |
|------------------------------|---|
| Nominal Input Voltage | 24 V DC |
| Input Voltage Range | 24 V DC \pm 20 % |
| Input Power | Max. 3 A |
| Output Current 3.3 V | 1 A |
| Output Current 5 V | 2 A |
| Output Current DOUT (24 V) | 2.5 A |
| Input Power Mating Connector | 2-pin Phoenix Contact 180° FMC 1,5/2-ST-3,5 (Phoenix 1826680) |



Information

The CR1220 coin cell battery is solely used to power the real time clock (RTC) and has no function in the rest of the system's power supply.



Information

The power consumption of the BL i.MX8M Mini varies depending on the installed components and external peripherals, for more information see Table 10: Power Consumption



NOTICE

The maximum output current of all outputs together is divided between the 5 V and 3 V paths. The maximum output currents for 5 V and 3 V shown in Table 9 refer to the use of that voltage only and are reduced accordingly when both voltages are used.

Power Consumption

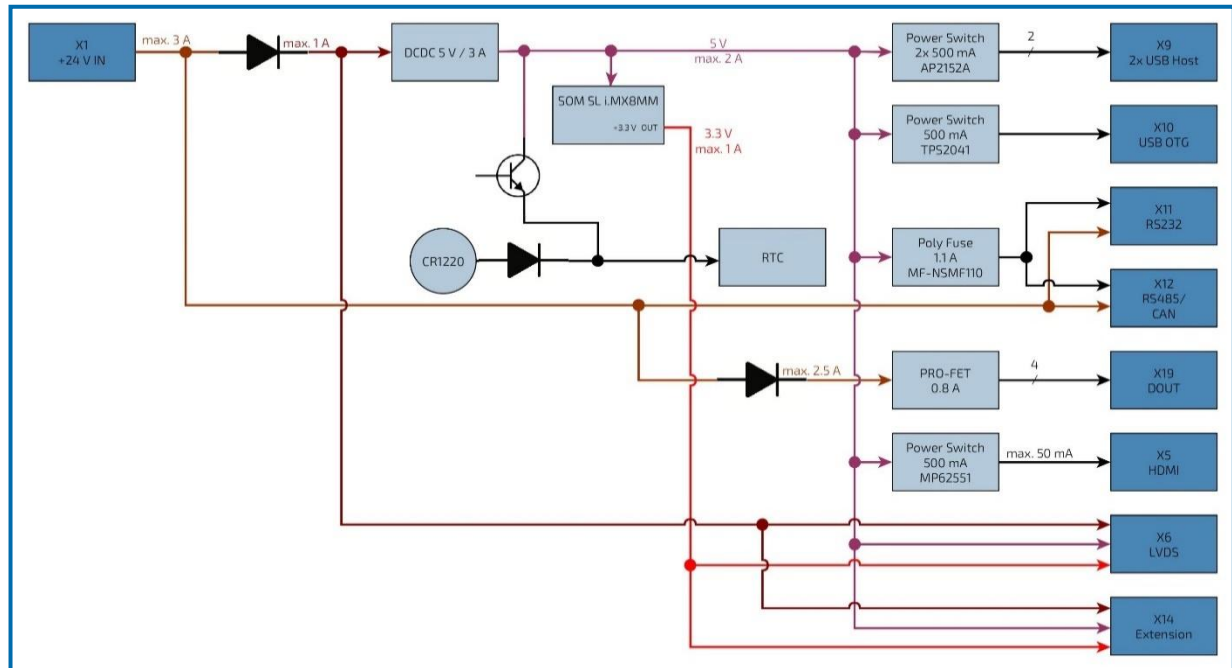


Figure 4: Power Tree

Table 10: Power Consumption

| Power Figures SBC | BL i.MX8M Mini |
|----------------------------|---|
| iMX8M Mini Deep Sleep Mode | not supported |
| iMX8M Mini idle default | 570 mW |
| iMX8M Mini run | 670...2400 mW |
| 1x LVDS | Backlight: $3.3\text{ V} * 1000\text{ mA} = 3.3\text{ W}$ or $5.0\text{ V} * 2000\text{ mA} = 10\text{ W}$ or $24\text{ V} * 300\text{ mA} = 7.2\text{ W}$ |
| 1x HDMI | $5\text{ V} * 50\text{ mA} = 250\text{ mW}$ |
| LAN 1 | 600 mW |
| LAN 2 | 300 mW |
| 2x USB 2.0 | $2x\ 5\text{ V} * 500\text{ mA} = 5\text{ W}$ |
| 1x USB OTG | $5\text{ V} * 500\text{ mA} = 2.5\text{ W}$ |
| DOUT | $2.5\text{ A} * 24\text{ V} = 60\text{ W}$ |

i.MX8M Mini power numbers are typical values based on typical silicon at 25 °C. Power numbers distributed to external devices are max. allowed values, partially overcurrent protected.



NOTICE

Please refer to NXP i.MX8M Mini Power Consumption Application Note for further details.

9.5 Earthing System

A functional earth connection to the board will be possible via the four mounting holes. These contact surfaces are directly attached to the electronic ground and the GND pin of the power connector.

9.6 Functional Block Diagram

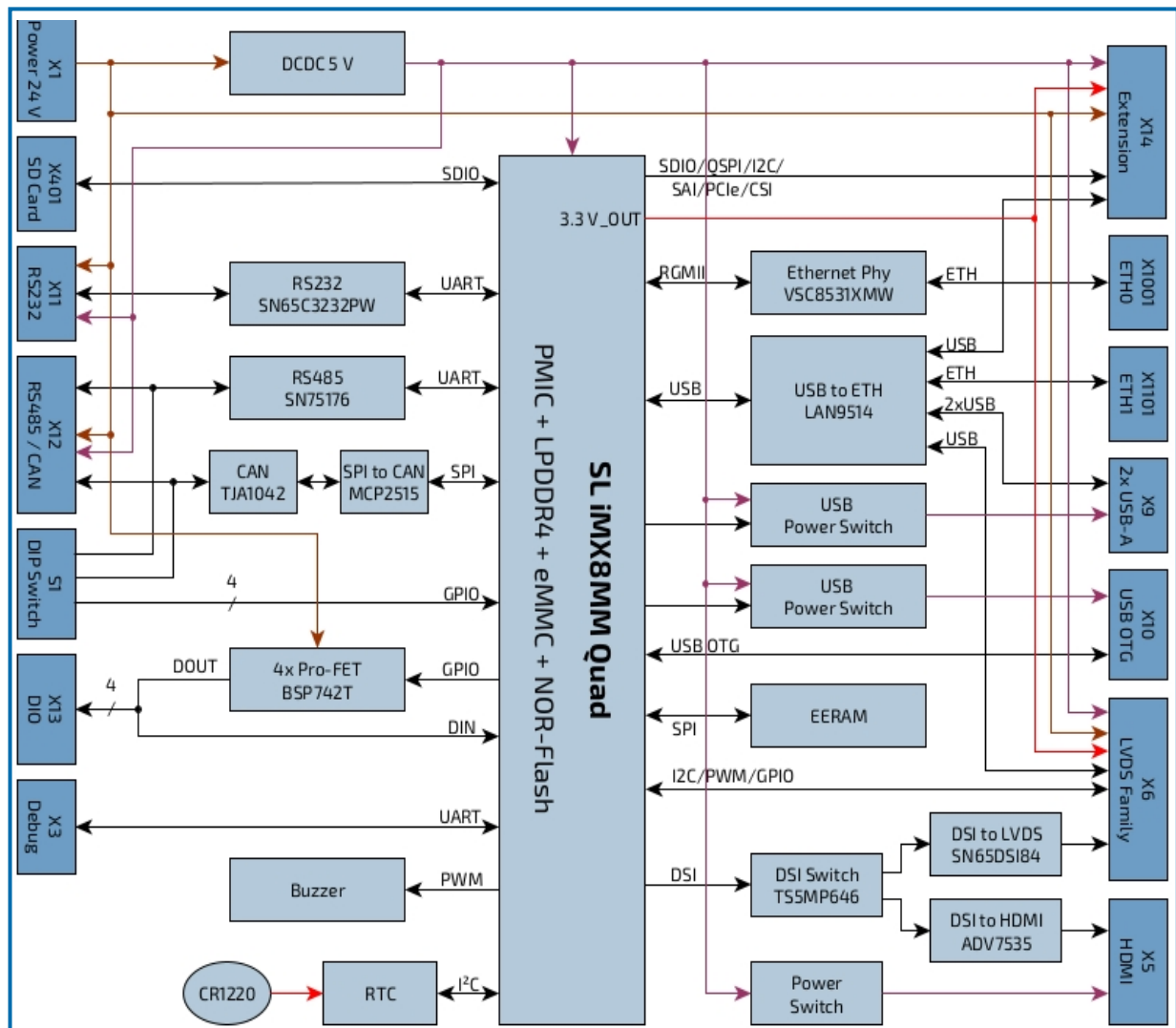


Figure 5: Block Diagram

9.7 Thermal Considerations



CAUTION hot Surface

There is a risk of injury from touching heated components or the board.

- Do not touch the board when the product is in operation.
- Allow the product to cool before handling.
- Wear protective gloves.
- Always turn the product off when not in use.

The BL i.MX8M Mini is a fanless and passively cooled system. When mounting the BL i.MX8M Mini in a housing take care not to obstruct the airflow over the components, as this stops sufficient heat dispersing into the ambient environment and causes a build-up of heat.



Information

The BL i.MX8M Mini is designed for operation in a customer-specific enclosure or device. Please do not operate the BL i.MX8M Mini without sufficient cooling system. The maximum temperature range refers only to the limits of the individual components.

9.8 Standards, Certifications and Directives

The BL i.MX8M Mini has been designed and tested in accordance with the following standards.



Information

If the user modifies the product, prerequisites for specific approvals such as CE conformity declaration (safety requirements) may no longer apply.

Table 11: Standards, Certifications and Directives Compliance

| | | |
|---|----------------------------------|---|
| CE-Mark Compliant with EU Directives | Electromagnetic Compatibility | Directive 2014/30/EU |
| | General Product Safety | Directive 2001/95/EG |
| | RoHS II | Directive 2011/65/EU + (EU)2015/863 |
| EMC 2014/30/EU Immunity/ Emission | EN 61000-6-2:2019 | Electromagnetic compatibility (EMC), part 6-2: Generic Standards- Immunity for industrial environment |
| | EN 61000-6-3:2007+A1:2011 | Electromagnetic compatibility (EMC), part 6-3: Generic Standards- Emission for industrial environment |
| Safety 2001/95/EG | EN 62368-1:2020+A11:2020 | Audio/video, information and communication technology equipment - Part 1: Safety requirements |

10 Board and Connectors

Most of the I/O connectors are located on the top side of the board.

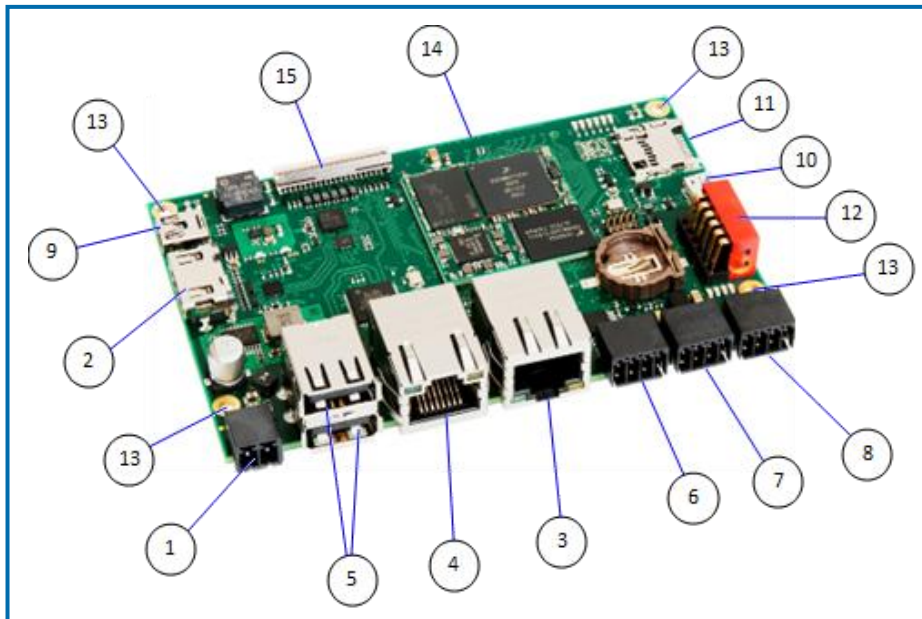


Figure 6: Top Side View

Table 12: Overview of all Connectors

| Item | Label | Function | See Chapter |
|------|-------------------|---|-------------|
| 1 | X1 | DC Power Connector (2-pin Phoenix Contact) | 10.2.1 |
| 2 | X5 | HDMI Connector | 10.2.2 |
| 3 | X1001 | 1 Gbit/s LAN1 RJ-45 Connector | 10.2.3 |
| 4 | X1101 | 10/100 Mbit/s LAN2 RJ-45 Connector | 10.2.4 |
| 5 | X9 | USB2.0 Port 0 / 1 Connector (upper / lower) | 10.2.5 |
| 6 | X11 | RS232 Connector | 10.2.6 |
| 7 | X12 | RS485 / CAN Connector | 10.2.7 |
| 8 | X13 | DIO Connector | 10.2.9 |
| 9 | X3 | Debug UART Connector | 10.2.10 |
| 10 | X10 | USB OTG Connector | 10.2.11 |
| 11 | X401 | MicroSD Card Slot | 10.2.14 |
| 12 | S1 | Switch CAN Address | 10.2.8 |
| 13 | FE | Functional Earth Connection | 10.1.12 |
| 14 | X14 (bottom side) | Extension Connector | 10.2.13 |
| 15 | X6 | LVDS Connector | 10.2.12 |

10.1 Connector Details

10.1.1 Power Connector

There is one 2-pin power connector on the top side of the board supporting an input DC voltage range of 24 V DC $\pm 20\%$, see Figure 6 (pos. 1). The mating connector required to connect the power connector to a DC main power source is supplied with the BL i.MX8M Mini. For information on how to connect the supplied mating connector to the input power source, refer to Chapter 7.2: Wiring the DC Mating Power Connector.

For the pin assignment of the input power connector, refer to Chapter 10.2.1: Input Power Connector (X1).

10.1.2 HDMI Interface

There is one HDMI interface (1920 x 1080 pixel resolution), for video solutions, see Figure 6 (pos. 2). The HDMI interface is not designed for connecting cables longer than 3 m. Depending on the monitor and the installation situation, a suitable HDMI cable with folding ferrite must be selected.

For the pin assignment of the HDMI connector, refer to Chapter 10.2.2: HDMI Connector (X5)

10.1.3 Ethernet (LAN2, LAN1) Interface

There are two LAN ports, see Figure 6 (pos. 3 and 4). In the software these are referred to as ETH0 and ETH1. The assignment between LAN2/LAN1 and ETH0/ETH1 depends on the software. In order to achieve the specified performance of the Ethernet port, shielded category 5 twisted pair cables must be used with 10/100 Mbit/s and Category 5E, 6 or 6E with 1 Gbit/s LAN networks. For the pin assignment of the RJ45 Ethernet connectors, refer to Chapter 10.2.3: Ethernet RJ45 Connector (X1001)

10.1.4 USB 2.0 Interface

There are two USB 2.0 ports allowing for the connection of USB 2.0 compatible devices, see Figure 6 (pos. 5). The USB ports are designed for connecting short cables only.

For the pin assignment of the USB 2.0 connector, refer to Chapter 10.2.5: USB Connector (X9)

10.1.5 RS232 Interface

There is a RS232 interface (RX/TX) supporting RTS/CTS, see Figure 6 (pos. 6). The RS232 interface is not designed for connecting cables longer than 3 m.

For the pin assignment of the RS232 connector, refer to Chapter 10.2.6: RS232 Connector (X11)

10.1.6 RS485 Interface

The RS485 interface in Figure 6 (pos. 7) contains also the wiring for CAN. The RS485 interface is not designed for connecting cables longer than 30 m.

For the pin assignment of the RS485/CAN connector, refer to Chapter 10.2.7: RS485/CAN Connector (X12)

10.1.7 CAN Interface

The CAN interface in Figure 6 (pos. 7) also contains the wiring for RS485. The CAN address switches 1...4 are connected directly to GPIO pins and can therefore also be used for other purposes. The CAN interface is not designed for connecting cables longer than 30 m.

For the pin assignment of the RS485/CAN connector, refer to Chapter 10.2.7: RS485/CAN Connector (X12)

10.1.8 DIO Interface

There is a four port DIO interface available on the front of the BL i.MX8M Mini, see Figure 6 (pos. 8).

The DIO pins consist of a 24 V high side switch, capable of driving 800 mA. The voltage level is according to the supply voltage. When the output is disabled, the pin can be used as 24 V input.

The DIO interface is not designed for connecting cables longer than 30 m.

For the pin assignment of the DIO connector, refer to Chapter 10.2.9: DIO Connector (X13)

10.1.9 Debug Interface

There is a Debug interface using UART protocol with a Mini-B USB connector, see Figure 6 (pos. 9).

The USB OTG interface is for service and should only be used by qualified personnel.

An additional adapter is needed to translate the UART signals provided on the Mini-B USB connector to USB. This adapter must be connected between an USB port on your computer and the debug interface on the BL i.MX8M Mini using a standard USB cable.

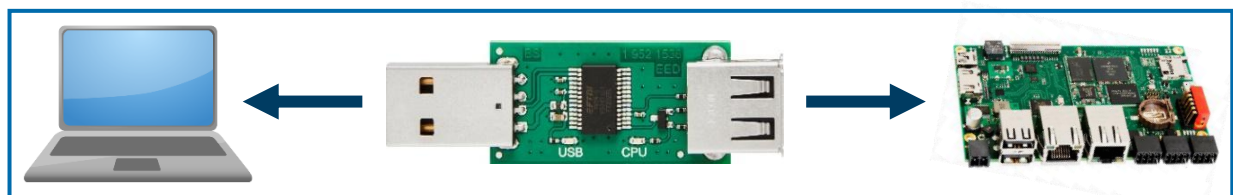


Figure 7: USB-UART Debug-Adapter

This adapter is only supplied as standard with our development kits but can also be ordered separately.

For more detailed information please have a look at the online documentation <https://docs.kontron-electronics.de>.

This documentation includes all information you need to put your device into operation including a quick start guide as well as further information on how to get access to the Yocto based GitLab software repository and how to make your own software images.

For the pin assignment of the debug connector, refer to Chapter 10.2.10: USB Debug Connector (X3)

10.1.10 USB OTG Interface

There is a Micro-USB OTG interface that can act as USB 2.0 compatible device or host, see Figure 6 (pos. 10).

The USB OTG interface is for service and should only be used by qualified personnel.

For the pin assignment of the USB OTG connector, refer to Chapter 10.2.11: USB OTG Connector (X10)

10.1.11 MicroSD Card Slot

There is a card slot to connect a microSD card for extra memory, see Figure 6 (pos. 11).

For the pin assignment of the microSD card slot, refer to Chapter 10.2.14: MicroSD Card Slot

10.1.12 Functional Earth Connection

The GND pin of the power connector is connected to functional earth of the electronics and to the four mounting holes on the edges of the circuit board, see Figure 6 (pos. 13).

10.1.13 LVDS Interface

There is a LVDS interface to connect a LVDS display, see Figure 6 (pos. 15).

For the pin assignment of the LVDS connector, refer to Chapter 10.2.12: LVDS-Family Connector (X6).

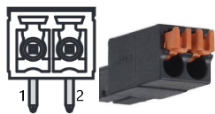
10.1.14 Extension Connector

There is an extension connector for connecting customized add-on boards, see Figure 6 (pos. 14).

For the pin assignment of the extension connector, refer to Chapter 10.2.13: Extension Connector (X14)

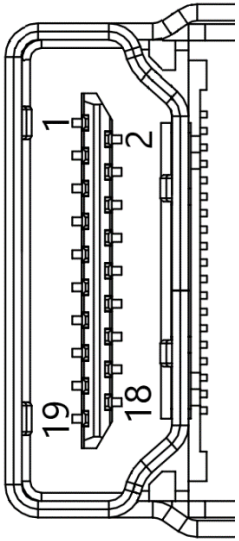
10.2 Connector Pin Assignments

10.2.1 Input Power Connector (X1)

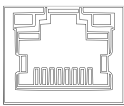
| 2-Pin Power Mating Connector | Pin | Signal Name |
|---|-----|-------------|
|  | 1 | VCC |
| | 2 | GND |
| | | |

Phoenix Contact Connector 180° FMC 1,5/2-ST-3,5 (Phoenix 1826680)

10.2.2 HDMI Connector (X5)

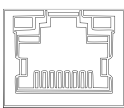
| HDMI | Pin | Signal Name |
|--|-----|-----------------|
|  | 1 | TMDS Data2+ |
| | 2 | GND |
| | 3 | TMDS Data2- |
| | 4 | TMDS Data1+ |
| | 5 | GND |
| | 6 | TMDS Data1- |
| | 7 | TMDS Data0+ |
| | 8 | GND |
| | 9 | TMDS Data0- |
| | 10 | TMDS Clock+ |
| | 11 | GND |
| | 12 | TMDS Clock- |
| | 13 | Reserved |
| | 14 | Reserved |
| | 15 | DDC_CLK |
| | 16 | DDC_DATA |
| | 17 | GND |
| | 18 | +5 V Power |
| | 19 | Hot Plug Detect |

10.2.3 Ethernet RJ45 Connector (X1001)

| RJ45 (female) | Pin | Signal Name | Pin | Signal Name |
|---|-----|-------------|-----|-------------|
|  | 1 | TX0+ | 5 | TX2- |
| | 2 | TX0- | 6 | TX1- |
| | 3 | TX1+ | 7 | TX3+ |
| | 4 | TX2+ | 8 | TX3- |

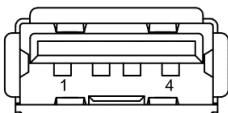
| Left LED: Activity / Link | | Right LED: Activity 10/100/1000 | |
|---------------------------|-------------------------|---------------------------------|---------------------|
| Off | 10 Mbit/s | Off | No LAN connectivity |
| Green | 100 Mbit/s, 1000 Mbit/s | Yellow | Link |
| | | Blinking | Activity |

10.2.4 Ethernet RJ45 Connector (X1101)

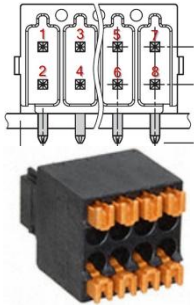
| RJ45 (female) | Pin | Signal Name | Pin | Signal Name |
|---|-----|-------------|-----|-------------|
|  | 1 | TX+ | 5 | n.c. |
| | 2 | TX- | 6 | RX- |
| | 3 | RX+ | 7 | n.c. |
| | 4 | n.c. | 8 | n.c. |

| Left LED: Activity / Link | | Right LED: Activity 10/100 | |
|---------------------------|------------|----------------------------|---------------------|
| Off | 10 Mbit/s | Off | No LAN connectivity |
| Green | 100 Mbit/s | Yellow | Link |
| | | Blinking | Activity |

10.2.5 USB Connector (X9)

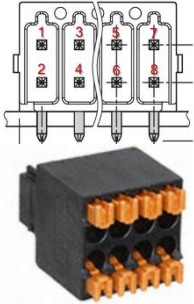
| 2x USB A 2.0 | Pin | Signal Name |
|---|-----|-------------|
|  | 1 | +USB_VCC |
| | 2 | D- |
| | 3 | D+ |
| | 4 | GND |

10.2.6 RS232 Connector (X11)

| RS232 Interface | Pin | RS232 |
|---|-----|---------|
|  | 1 | VIN |
| | 2 | GND |
| | 3 | TxD |
| | 4 | RxD |
| | 5 | RTS |
| | 6 | CTS |
| | 7 | +5 V DC |
| | 8 | GND |

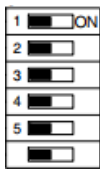
Phoenix Contact Connector 180° DFMC 0,5/4-ST-2,54 (Phoenix 1844594)

10.2.7 RS485/CAN Connector (X12)

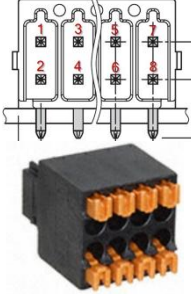
| RS485/CAN Interface | Pin | Signal Name |
|--|-----|-------------|
|  | 1 | VIN |
| | 2 | GND |
| | 3 | RS485 A |
| | 4 | CAN H |
| | 5 | RS485 B |
| | 6 | CAN L |
| | 7 | +5 V DC |
| | 8 | GND |

Phoenix Contact Connector 180° DFMC 0,5/4-ST-2,54 (Phoenix 1844594)

10.2.8 CAN Address and Termination Switch (S1)

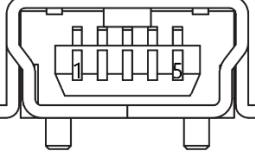
| CAN Address | Switch | Signal Name |
|---|--------|---------------------------|
|  | 1 | Address 1 |
| | 2 | Address 2 |
| | 3 | Address 3 |
| | 4 | Address 4 |
| | 5 | CAN Termination (121 Ω) |
| | 6 | RS485 Termination (121 Ω) |

10.2.9 DIO Connector (X13)

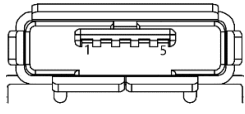
| DIO Interface | Pin | Signal Name | Pin | Signal Name |
|---|-----|--|-----|-------------|
|  | 1 | DOUT1 / DIN1 DOUT I _{max} = 800 mA | 2 | GND |
| | 3 | DOUT2 / DIN2 DOUT I _{max} = 800 mA | 4 | GND |
| | 5 | DOUT3 / DIN3 DOUT I _{max} = 800 mA | 6 | GND |
| | 7 | DOUT4 / DIN4 DOUT I _{max} = 800 mA | 8 | GND |

Phoenix Contact Connector 180° DFMC 0,5/4-ST-2,54 (Phoenix 1844594)

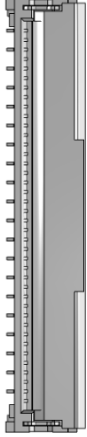
10.2.10 USB Debug Connector (X3)

| Mini-B USB Connector | Pin | Signal Name |
|--|-----|-------------|
|  | 1 | VCC |
| | 2 | RXD |
| | 3 | TXD |
| | 4 | N.C. |
| | 5 | GND |

10.2.11 USB OTG Connector (X10)

| Micro-USB Connector | Pin | Signal Name |
|---|-----|-------------|
|  | 1 | +USB_VCC |
| | 2 | D- |
| | 3 | D+ |
| | 4 | ID |
| | 5 | GND |

10.2.12 LVDS-Family Connector (X6)

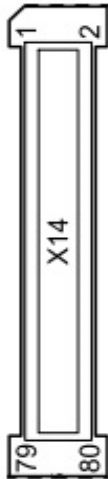
| ZIF 40-pin | Pin | Signal Name | Pin | Signal Name |
|--|-----|-------------|-----|-------------|
|  | 1 | VCC 3.3 V | 21 | RXIN3+ |
| | 2 | VCC 3.3 V | 22 | GND |
| | 3 | VCC 3.3 V | 23 | USB_DN |
| | 4 | GPIO0 | 24 | USB_DP |
| | 5 | GPIO1 | 25 | GND |
| | 6 | STBY | 26 | I2C2_SDA |
| | 7 | GND | 27 | I2C2_SCL |
| | 8 | RXINO- | 28 | TOUCH_INT |
| | 9 | RXINO+ | 29 | TOUCH_RST |
| | 10 | GND | 30 | GND |
| | 11 | RXIN1- | 31 | +24 V |
| | 12 | RXIN1+ | 32 | +24 V |
| | 13 | GND | 33 | GPIO2 |
| | 14 | RXIN2- | 34 | GPIO3 |
| | 15 | RXIN2+ | 35 | PWM1 |
| | 16 | GND | 36 | GND |
| | 17 | RXCLKIN- | 37 | GND |
| | 18 | RXCLKIN+ | 38 | +5 V |
| | 19 | GND | 39 | +5 V |
| | 20 | RXIN3- | 40 | +5 V |

Connector Type

X6: Molex ZIF-Buchse 501951-4010 (180° FPC 40 pol. RM0,5)

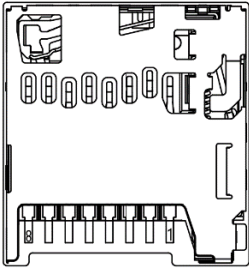
10.2.13 Extension Connector (X14)

| Hirose 80pol. | Pin | Signal Name | Pin | Signal Name |
|---------------|-----|------------------------|-----|--------------------------|
| | 1 | +24 V | 41 | USB DM 5 |
| | 2 | VDD_RTC | 42 | I2C2_SDA |
| | 3 | +24 V | 43 | UDB DP 5 |
| | 4 | GND | 44 | NAND_CEO_B(QSPIA_nSS0) |
| | 5 | +24 V | 45 | GND |
| | 6 | +3.3 V | 46 | NAND_ALE(QSPIA_SCLK) |
| | 7 | GND | 47 | PRT CTL 5 |
| | 8 | +3.3 V | 48 | NAND_DATA00(QSPIA_DATA0) |
| | 9 | +5 V | 49 | n.c. |
| | 10 | GND | 50 | NAND_DATA01(QSPIA_DATA1) |
| | 11 | +5 V | 51 | MIPI_CSI_CLK_P |
| | 12 | GND | 52 | NAND_DATA02(QSPIA_DATA2) |
| | 13 | +5 V | 53 | MIPI_CSI_CLK_N |
| | 14 | NAND_DATA04(SD3_DATA0) | 54 | NAND_DATA03(QSPIA_DATA3) |
| | 15 | GND | 55 | GND |
| | 16 | NAND_DATA05(SD3_DATA1) | 56 | GND |
| | 17 | n.c. | 57 | MIPI_CSI_D0_P |
| | 18 | NAND_DATA06(SD3_DATA2) | 58 | UART2_TXD(ECSPI3_SS0) |
| | 19 | n.c. | 59 | MIPI_CSI_D0_N |
| | 20 | NAND_DATA07(SD3_DATA3) | 60 | UART1_RXD(ECSPI3_SCLK) |
| | 21 | GND | 61 | GND |
| | 22 | GND | 62 | UART2_RXD(ECSPI3_MISO) |
| | 23 | GND | 63 | MIPI_CSI_D1_P |
| | 24 | NAND_WP_B(SD3_CMD) | 64 | UART1_TXD(ECSPI3_MOSI) |
| | 25 | PCIE_CLK_P | 65 | MIPI_CSI_D1_N |
| | 26 | NAND_WE_B(SD3_CLK) | 66 | SAI1_MCLK |
| | 27 | PCIE_CLK_N | 67 | GND |
| | 28 | GND | 68 | SAI1_TXC |
| | 29 | GND | 69 | MIPI_CSI_D2_P |
| | 30 | NAND_RE_B(SD3_DATA4) | 70 | SAI1_TXFS |
| | 31 | PCIE_RXN_P | 71 | MIPI_CSI_D2_N |
| | 32 | NAND_CE2_B(SD3_DATA5) | 72 | SAI1_RXD0 |
| | 33 | PCIE_RXN_N | 73 | GND |
| | 34 | NAND_CE3_B(SD3_DATA6) | 74 | GND |
| | 35 | GND | 75 | MIPI_CSI_D3_P |
| | 36 | NAND_CLE(SD3_DATA7) | 76 | SAI1_TXD0 |
| | 37 | PCIE_TXN_P | 77 | MIPI_CSI_D3_N |
| | 38 | GND | 78 | SAI1_RXD1 |
| | 39 | PCIE_TXN_N | 79 | GND |
| | 40 | I2C2_SCL | 80 | SAI1_TXD1 |



Connector Type X14: Hirose FX10A-80P/8-SV1(91)

10.2.14 MicroSD Card Slot

| MicroSD Card | Pin | Signal Name |
|---|-----|-------------|
|  | 1 | DTA2 |
| | 2 | CD/DAT3 |
| | 3 | CMD |
| | 4 | VDD |
| | 5 | CLK |
| | 6 | VSS |
| | 7 | DAT0 |
| | 8 | DAT1 |



Information

Pay attention to the manufacturer's lifespan specification. Due to the limited lifespan of SD-Cards/SSD drives Kontron Electronics recommends checking the condition regularly.

11 Accessing Components and Extending the Device

This chapter contains important information that users must read before accessing components. Follow these procedures properly when accessing or installing component to extend the system.



CAUTION

The installation/removal of system components may only be performed by a qualified person. Please observe the "Safety Instructions" contained within this user guide.



ESD Sensitive Device

Follow the safety instructions for components that are sensitive to electrostatic discharge (ESD). Failure to observe this warning notice may result in damage to the product or/and internal components



Information

Because of the limited predetermined lifespan of expansion devices, Kontron Electronics recommends checking the condition of installed expansion devices regularly and to pay attention to the manufacturer specifications for lifespan.

11.1 MicroSD Card Slot

The BL i.MX8M Mini supports a removable microSD card.

To remove/install a removable microSD card, perform the following steps:

- Press the microSD card on the right-hand side of the BL i.MX8M Mini to remove a microSD card out of the slot.
- The microSD card automatically slides out a bit for removal.
- Slide in the microSD card, if needed. Take care of the correct position.

11.2 Extending the Device

- When installing additional modules, ensure that the workspace is clean.
- After installing the additional modules, please check the product for any damage.
- The power consumption of each additional module must not exceed the specified limit.
- Structural changes and modifications must be approved by Kontron Electronics. Unauthorised structural modifications and conversions will result in the loss of any warranty.
- Only trained personnel are authorised to handle and operate the device.

12 Storage, Transportation and Maintenance

12.1 Storage

If the product is not in use for an extended period time, disconnect the power. If it is necessary to store the product then re-pack the product as originally delivered to avoid damage. The storage facility must meet the products environmental requirements as stated within this user guide. Kontron Electronics recommends keeping the original packaging material for future storage or warranty shipments.

12.2 Transportation

To ship the product, use the original packaging, designed to withstand impact and adequately protect the product. When packing or unpacking products always take shock and ESD protection into consideration and use an EOS/ESD safe working area.

12.3 Maintenance

Maintenance or repair on the open product may only be carried out by qualified personnel authorized by Kontron Electronics.

Cleaning:

- For light soiling, clean the product with a dry cloth.
- Carefully remove dust from the surface of the chassis and cooling fins (if present) using a clean, soft brush.
- Stubborn dirt should be removed using a mild detergent and a soft cloth.



NOTICE

Do not use steel wool, metallic threads or solvents like abrasives, alcohol, acetone or benzene for cleaning the BL i.MX8M Mini.



WARNING

Keep the device dry. Exposure to water may cause damage to the device and pose a risk to the user.

12.4 Replacing the Coin Cell Battery

The coin cell battery (CR1220) must only be replaced with the same type of battery or with a type of battery recommended by Kontron Electronics. If the on-board Lithium battery needs to be replaced, follow the steps below:

- Remove the lithium battery from the holder by pulling it outwards.
- Place a new lithium battery in the battery holder.
- Pay attention to the polarity of the battery.



WARNING

Risk of explosion if the battery is not replaced in accordance with the instructions! (short circuit, reverse polarity, wrong type of battery) Dispose of used batteries in accordance with the manufacturer's instructions.



NOTICE

Do not dispose of coin batteries in general trash collection. Dispose of the battery according to the local regulations dealing with the disposal of these special materials, (e.g. to the collecting points for dispose of batteries).

13 Technical Support

13.1 First Steps – Startup Information Baseboard

For the first startup of the BL i.MX8M Mini, you will find more information and known issues about the software / BSP (demo) and additional hardware information at the online documentation.

Please follow the link: <https://docs.kontron-electronics.de/yocto-ktn/build-ktn-imx/>

The online documentation is primarily intended for our Development Kit but will help you also to put your BL i.MX8M Mini into operation. Additionally, you will find information how to get access to the Yocto based GitLab software repository and how to make your own software images.

Extended Support

For detailed technical support please contact:

E-Mail: support@kontron-electronics.de

Make sure you have the following product identification information in your e-mail:

- Product name
- Product model number
- Serial number (SN) of the unit

Please explain the nature of your problem in your e-mail.



Serial Number

The serial number can be found on the label on the system.

13.2 License Information

The demo software contained in the device (BSP) contains parts which were licensed as free respectively open-source software under the GNU General Public License, version 2 and/or 3, respectively the GNU Lesser General Public License, versions 2.1 and/or 3.0.

You can obtain a pre-configured demo image at <https://docs.kontron-electronics.de/> or contact:

Kontron Electronics GmbH
Max-Planck-Str. 6
72636 Frickenhausen
Germany

Web: www.kontron-electronics.com

E-Mail: support@kontron-electronics.de

14 Product Usage Life Cycle

14.1 Warranty

Kontron Electronics defines product warranty in accordance with regional warranty definitions. Claims are at Kontron Electronics discretion and limited to the defect being of a material nature. To find out more about the warranty conditions and the defined warranty period for your region, following the steps below:

1. Visit Kontron Electronics Term and Conditions webpage

www.kontron-electronics.com/downloads/

2. Click on the relevant document

Limitation/Exemption from Warranty Obligation

In general, Kontron Electronics shall not be required to honor the warranty, even during the warranty period, and shall be exempted from the statutory accident liability obligations in the event of damage caused to the product due to failure to observe the following:

- Safety instructions within this user guide
- Warning labels on the product and warning symbols within this user guide
- Information and hints within this user guide

Additionally, alterations or modifications to the product that are not explicitly approved by Kontron Electronics, described in this user guide, or received from Kontron Electronics Support as a special handling instruction will void your warranty.

Within the warranty period, the product should only be opened by Kontron Electronics. Removing the protection label and opening the product within the warranty period exempts the product from the statutory warranty obligation.

Due to their limited service life, parts which by their nature are subject to a particularly high degree of wear (wearing parts) are excluded from the warranty beyond that provided by law.

14.2 Quality and Environmental Management

Kontron Electronics aims to deliver reliable high-end products designed and built for quality, and aims to complying with environmental laws, regulations, and other environmentally oriented requirements. For more information regarding Kontron Electronics' quality and environmental responsibilities, visit www.kontron-electronics.com/company/about-us/germany/

14.3 Disposal and Recycling

Kontron Electronics' products are manufactured to satisfy environmental protection requirements where possible. Many of the components used are capable of being recycled. Final disposal of this product after its service life must be accomplished in accordance with applicable country, state, or local laws or regulations.

14.4 WEEE Compliance

The Waste Electrical and Electronic Equipment (WEEE) Directive aims to:

- Reduce waste arising from electrical and electronic equipment (EEE).
- Make producers of EEE responsible for the environmental impact of their products, especially when the product becomes waste.
- Encourage separate collection and subsequent treatment, reuse, recovery, recycling and sound environmental disposal of EEE.
- Improve the environmental performance of all those involved during the lifecycle of EEE.



Environmental Protection

Environmental protection is a high priority with Kontron Electronics.
 Kontron Electronics follows the WEEE directive.
 You are encouraged to return our products for proper disposal.

15 Appendix

List of Acronyms

Table 13: List of Acronyms

| Acronym | Description | Acronym | Description |
|---------|--|---------|---|
| AC | Alternating Current | HD/HDD | Hard Disk /Drive |
| AIN | Analog Input | HDMI | High-Definition Multimedia Interface |
| AL | Automation Line (Board with housing) | HPM | PICMG Hardware Platform Management specification family |
| BL | Board Line (Board without housing) | H/W | Hardware |
| BSP | Board Support Package (Software) | IEC | International Electrotechnical Commission (Standards) |
| CAN | Controller Area Network (BUS) | IOL | IPMI-Over-LAN |
| CPI | Advanced Configuration Control Interface | IOT | Internet of Things |
| CPU | Central Processing Unit | KVM | Keyboard Video Mouse |
| CSI | Camera Serial Interface | LAN | Local Area Network |
| DC | Direct Current | LED | Light Emitting Device / Diode |
| DIN | Deutsches Institut für Normung, German Institute for Standardization (Standards) | LPDDR | Low-Power Double Data Rate (RAM) |
| DIO | Digital Input/Output | LVD | Low Voltage Device |
| DK | Development Kit | M.2 | Next smaller generation of mSATA |
| DL | Display Line (Board with Display) | MEI | Management Engine Interface |
| DOUT | Digital Output | mPCIe | Mini PCI-Express |
| DP | Display Port | mSATA | Mini SATA |
| DSI | Display Serial Interface | OS | Operating System |
| ECC | Error Checking and Correction | PCIe | PCI-Express |
| EEE | Electrical and Electronic Equipment | RAM | Read Access Memory |
| EHCI | Enhanced Host Controller Interface | REV | Revision |
| EMC | Electromagnetic Compatibility | RoHS | Restriction of the use of certain hazardous substances |
| eMMC | Embedded MultiMediaCard | ROM | Read-only memory |
| EN | European Norm (Standards) | RTC | Real Time Clock |
| ESD | Electrostatic Discharge | SATA | Serial-ATA |
| ETH | Ethernet (LAN) | SEL | System Event Log |
| GbE | Gigabit Ethernet | SELV | Safety Extra Low Voltage |
| GPIO | General-Purpose Input/Output | SIO | Super Input/output |

| Acronym | Description | Acronym | Description |
|---------|---------------------------------------|---------|---|
| GPU | Graphics Processing Unit | SMBus | System Management Bus |
| SMWI | System Monitor Web Interface | USB | Universal Serial Bus |
| SN | Serial Number | USB OTG | USB On-The-Go (Host) |
| SOL | Serial Over LAN | uSD | microSD (Memory Card) |
| SSD | Solid State Drive | VGA | Video Graphics Array |
| TPM | Trusted Platform Module | VLP | Very Low Profile |
| UEFI | Unified Extensible Firmware Interface | WEEE | Waste Electrical and Electronic Equipment |
| uHDMI | Micro-HDMI | WLAN | Wireless LAN |
| UL | Underwriters Laboratories (Standards) | XHCI | eXtensible Host Controller Interface |

"List of Acronyms"



About Kontron

Kontron AG is a leading IoT technology company. For more than 20 years, Kontron has been supporting companies from a wide range of industries to achieve their business goals with intelligent solutions. From automated industrial operations, smarter and safer transport to advanced communications, connectivity, medical, and energy solutions, the company delivers technologies that add value for its customers. With the acquisition of Katek SE in early 2024, Kontron significantly strengthens its portfolio with the new GreenTec division, focusing on solar energy and eMobility, and grows to around 8,000 employees in over 20 countries worldwide. Kontron is listed on the SDAX® and TecDAX® of the German Stock Exchange.

For more information, please visit: www.kontron.com

About Kontron Electronics

Kontron Electronics GmbH is a full-service provider in the field of electronics, development and manufacturing services. Our business portfolio includes proprietary and client-specific products, development and design services for complex electronics components, modules and systems, as well as production and assembly services for entire devices. The company is part of the technology corporation Kontron AG.

For more information, please visit: www.kontron-electronics.com

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